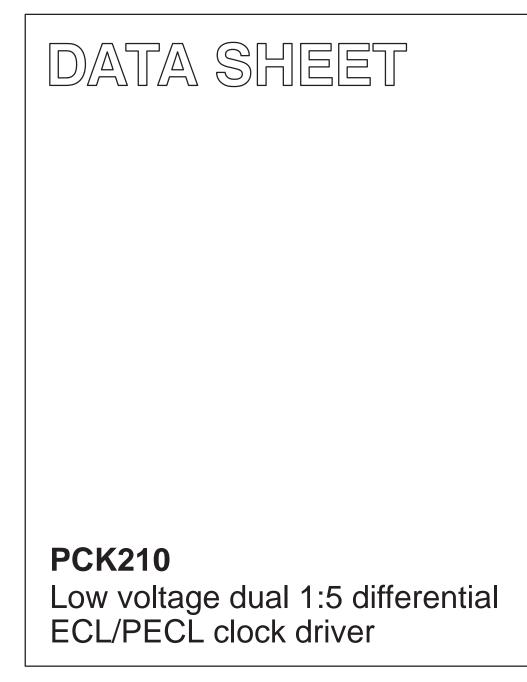
INTEGRATED CIRCUITS



Product data Supersedes data of 2002 Dec 13 2004 Apr 23



PCK210

FEATURES

- 85 ps part-to-part skew typical
- 20 ps output-to-output skew typical
- Differential design
- V_{BB} output
- Voltage and temperature compensated outputs
- Low voltage V_{EE} range of -2.25 V to -3.8 V
- 75 kΩ input pull-down resistors
- Form, fit, and function compatible with MC100EP210

DESCRIPTION

The PCK210 is a low skew 1-to-5 dual differential driver, designed with clock distribution in mind. The input signals can be either differential or single-ended if the V_{BB} output is used. The signal is fanned out to 5 identical differential outputs.

The PCK210 is specifically designed, modeled and produced with low skew as the key goal. Optimal design and layout serve to minimize gate-to-gate skew within a device, and empirical modeling is used to determine process control limits that ensure consistent t_{PD} distributions from lot to lot. The net result is a dependable, guaranteed low skew device.

To ensure that the tight skew specification is met, it is necessary that both sides of the differential output are terminated into 50 Ω , even if only one side is being used. In most applications, all ten differential pairs will be used, and therefore terminated. In the case where fewer than ten pairs are used, it is necessary to terminate at least the output pairs on the same package side as the pair(s) being used on that side, in order to maintain minimum skew. Failure to do this will result in small degradations of propagation delay (on the order of 10–20 ps) of the output(s) being used, which, while not being catastrophic to most designs, will mean a loss of skew margin.

The PCK210, as with most other ECL devices, can be operated from a positive V_{CC} supply in PECL mode. This allows the PCK210 to be used for high performance clock distribution in +3.3 V or +2.5 V systems. Designers can take advantage of the PCK210's performance to distribute low skew clocks across the backplane or the board. In a PECL environment, series or Thevenin line terminations are typically used as they require no additional power supplies.

The PCK210 may be driven single-endedly utilizing the V_{BB} bias output with the CLKA or CLKB input. If a single-ended signal is to be used, the V_{BB} pin should be connected to the CLKA or CLKB input and bypassed to ground via a 0.01 μ F capacitor. The V_{BB} output can only source/sink 0.3 mA, therefore, it should be used as a switching reference for the PCK210 only. Part-to-part skew specifications are not guaranteed when driving the PCK210 single-endedly.

PINNING

Pin configurations

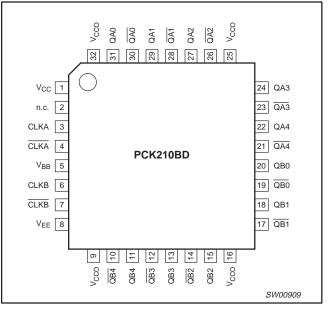


Figure 1. LQFP32 pin configuration

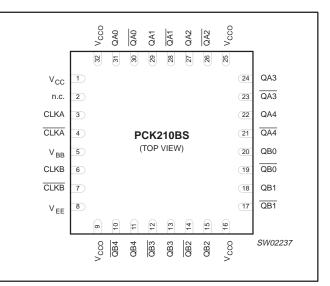


Figure 2. HVQFN32 pin configuration

ORDERING INFORMATION

Tuno numbor	Package	Temperature		
Type number	Name	Description	Version	range
PCK210BD	LQFP32	plastic low profile quad flat package; 32 leads; body $7\times7\times1.4$ mm	SOT358-1	–40 °C to +85 °C
PCK210BS	PCK210BS HVQFN32 plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 × 5 × 0.85 mm		SOT617-1	–40 °C to +85 °C

Pin description

SYMBOL	PIN	DESCRIPTION
V _{CC}	1	Supply voltage
n.c.	2	not connected
CLKA, CLKA	3, 4	Differential input pair
V _{BB}	5	V _{BB} output
CLKB, CLKB	6, 7	Differential input pair
V _{EE}	8	Ground
V _{CCO}	9, 16, 25, 32	Output drive power supply voltage
QA0–QA4, QB0–QB4	31, 29, 27, 24, 22, 20, 18, 15, 13, 11	Differential outputs
$\frac{\overline{QA0}}{\overline{QB0}} - \frac{\overline{QA4}}{\overline{QB4}},$	30, 28, 26, 23, 21, 19, 17, 14, 12, 10	Differential outputs

LOGIC SYMBOL

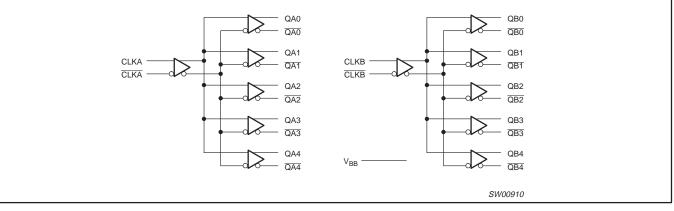


Figure 3. Logic symbol

PCK210

PCK210

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	LIM	UNIT	
STMBOL	PARAMETER	MIN MAX		
V _{CC}	Supply voltage	-0.3	+4.6	V
VI	Input voltage	-0.3	V _{CC} + 0.3	V
l _{IN}	Input current	-	±20	mA
T _{stg}	Storage temperature range	-40	+125	°C
ESD _{HBM}	Electrostatic discharge (Human Body Model; 1.5 k Ω , 100 pF)	-	>1750	V
ESD _{MM}	Electrostatic discharge (Machine Model; 0 kΩ, 100 pF)	-	>200	V
ESD _{CDM}	Electrostatic discharge (Charge Device Model)	-	>1000	V

NOTE:

1. Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{CC}	Supply voltage		2.25	3.8	V
V _{IR}	Receiver input voltage		V _{EE}	V _{CC}	V
V _{DIFF}	Input differential voltage ¹	V _(CLKinN) –V(CLKin)	—	1.00	V
T _{amb}	Operating ambient temperature range in free air		-40	+85	°C

NOTE:

 To idle an unused differential clock input, connect one input terminal (e.g. CLK1) to V_{BB} and leave its complimentary input terminal (e.g. CLK1) open-circuit, in which case CLK1 will default LOW by its internal pull-down reistor. Inputs should not be shorted to ground or V_{CC}.

THERMAL CHARACTERISTICS

Proper thermal management is critical for reliable system operation. This is especially true for high fan-out and high drive capability products.

DC ELECTRICAL CHARACTERISTICS

 V_{supply} : V_{CC} = V_{CCO} = 0.0 V; V_{EE} = –2.25 V to –3.80 V.

SYMBOL	PARAMETER	CONDITIONS	–40 °C		+25 °C		+85 °C			
STWDUL	FARAMETER	CONDITIONS	MIN	MAX	MIN	MAX	MIN	MAX		
I _{EE}	Internal supply current	Absolute value of current	20	80	20	85	30	90	mA	
I _{CC}	Output and internal supply currentAll outputs terminated 50Ω to $V_{CC} - 2.0 V$		270	390	270	395	270	405	mA	
I _{IN}	Input current Includes pull-up/pull-do resistors		-	150	-	150	-	150	μA	
V_{BB}	Internally generated bias voltage	for V _{EE} = -2.25 V to -3.8 V	-1.38	-1.16	-1.38	-1.16	-1.38	-1.16	V	
V_{PP}	Input amplitude	$ \begin{array}{l} \text{Difference of input} \\ \approx V_{IH} - V_{IL} \ (\text{Note 1}) \end{array} \end{array} $	0.5	1.3	0.5	1.3	0.5	1.3	V	
V _{CMR}	R Common mode voltage Crosspoint of input \approx average (V _{IH} , V _{IL})		V _{EE} + 1.0	-0.3	V _{EE} + 1.0	-0.3	V _{EE} + 1.0	-0.3	V	
V _{OH}	HIGH-level output voltage	I _{OH} = -30 mA	-1.30	-0.95	-	-	-1.20	-0.85	V	
V _{OL}	LOW-level output voltage	I _{OL} = -5 mA	-1.85	-1.40	-	_	-1.90	-1.50	V	
V _{OUTpp}	Differential output swing		350	_	-	_	500	_	mV	

DC ELECTRICAL CHARACTERISTICS

 V_{supply} : V_{CC} = V_{CCO} = 2.25 V to 3.80 V; V_{EE} = 0.0 V.

SYMBOL	PARAMETER	CONDITIONS	–40 °C		+25	S°C	+85		
STNBOL		CONDITIONS	MIN	MAX	MIN	MAX	MIN	MAX	
I _{EE}	Internal supply current	Absolute value of current	20	80	20	85	30	90	mA
I _{CC}	Output and internal supply current	All outputs terminated 50 Ω to V _{CC} – 2.0 V	270	390	270	395	270	405	mA
I _{IN}	Input current	Includes pull-up/ pull-down resistors	-	150	-	150	-	150	μA
V_{BB}	Internally generated bias voltage	V_{CC} = 2.25 V to 3.8 V	V _{CC} – 1.38	V _{CC} – 1.16	V _{CC} – 1.38	V _{CC} – 1.16	V _{CC} – 1.38	V _{CC} – 1.16	V
V _{PP}	Input amplitude	Difference of input $\approx V_{IH} - V_{IL}$ (Note 1)	0.5	1.3	0.5	1.3	0.5	1.3	V
V _{CMR}	Common mode voltage	Crosspoint of input \approx average (V _{IH} , V _{IL})	1	V _{CC} – 0.3	1	V _{CC} – 0.3	1	$V_{CC} - 0.3$	V
V _{OH}	HIGH-level output voltage			V _{CC} – 0.95	-	-	V _{CC} – 1.20	V _{CC} – 0.85	V
V _{OL}	LOW-level output voltage	$I_{OL} = -5 \text{ mA}$		V _{CC} – 1.40	-	-	V _{CC} – 1.90	V _{CC} – 1.50	V
V _{OUTpp}	Differential output swing		350	-	-	_	500	-	mV

NOTE:

1. V_{PP} minimum and maximum required to maintain AC specifications. Actual device function will tolerate minimum V_{PP} of 100 mV.

PCK210

AC CHARACTERISTICS — PECL input

 V_{supply} : $V_{CC} = V_{CCO} = 2.25 \text{ V to } 3.80 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ $-OR - V_{CC} = V_{CCO} = 0.0 \text{ V}$; $V_{EE} = -2.25 \text{ V to } -3.80 \text{ V}$.

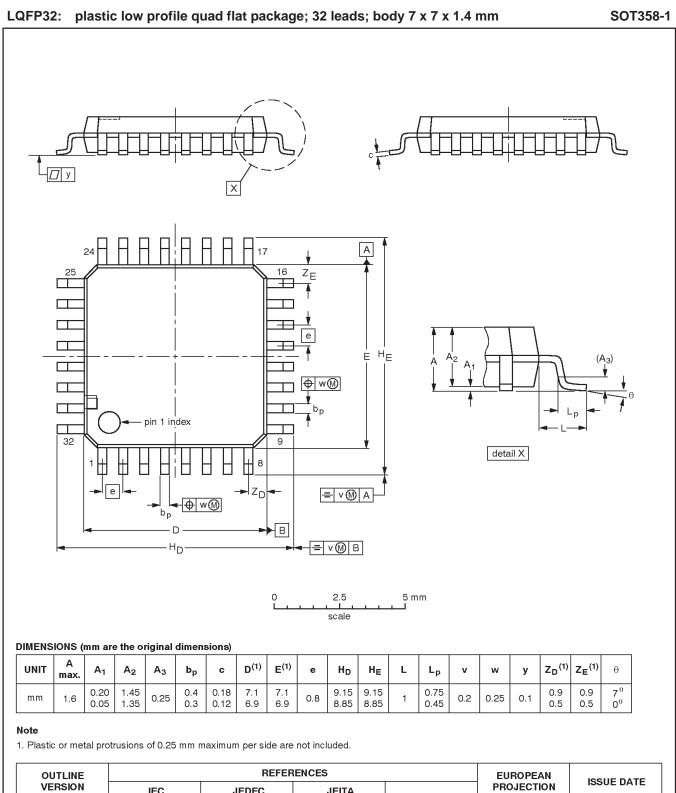
SYMBOL	PARAMETER	CONDITIONS	–40 °C			+25 °C			+85 °C			
STWDUL	FARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
t _{PD}	Differential propagation delay CLK,CLK to all Q0,Q0 through Q4,Q4	Nominal (single input condition) $V_{PP} = 0.650 V$, $V_{CMR} = V_{CC} - 0.800 V$ Applies to 500 MHz reference. (Note 1)	270	_	420	300	_	450	380	-	530	ps
t _{SK(part)}	Part-to-part skew	Single input condition (Note 1)	-	-	110	-	-	110	-	-	110	ps
t _{SK(output)}	Output-to-output skew for given part	Single input condition (Note 1)	-	15	50	-	15	50	-	15	50	ps
t _{PD}	Differential propagation delay CLK, <u>CLK</u> to all Q0, $\overline{Q0}$ through Q4, $\overline{Q4}$	All input conditions (Note 1)	220	_	520	250	_	550	320	-	620	ps
t _{SK(part)}	Part-to-part skew	(Note 1)	-	-	160	-	-	160	-	-	160	ps
t _{SK(output)}	Output-to-output skew for given part	(Note 1)	-	15	50	-	15	50	-	15	50	ps
t _{jitter}	Cyle-to-cycle jitter		-	-	1	-	-	1	-	-	1	ns
f _{MAX}	Maximum frequency	Functional to 1.5 GHz Timing specifications apply up to 1.0 GHz	1500		-	-	1500	-	_	1500	MHz	
t _r , t _f	Output rise and fall times (20%, 80%)	(Note 1)	100	_	320	100	_	320	100	_	320	ps

NOTE:

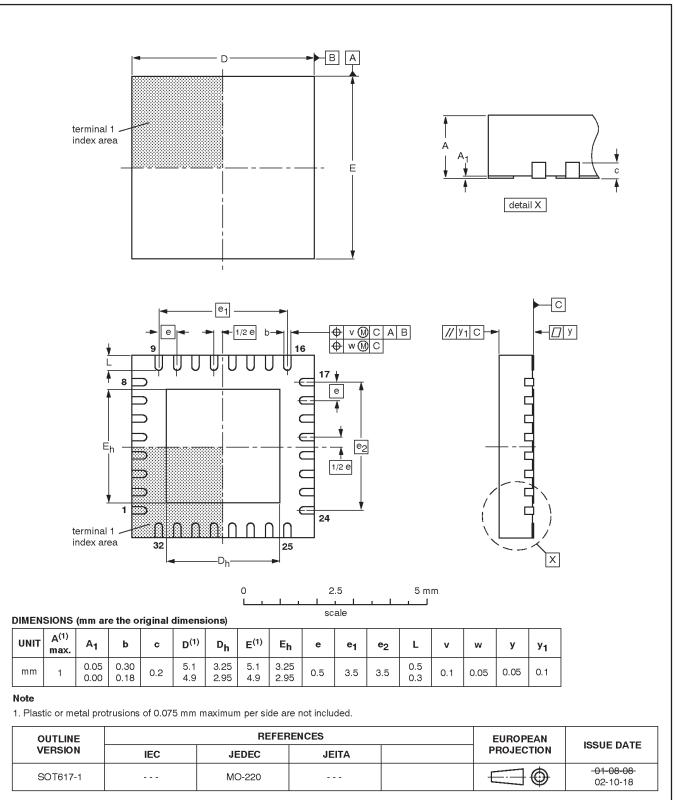
1. For operation with 2.5 V supply, the output termination is 50 Ω to V_{EE}. For operation at 3.3 V supply, the output termination is 50 Ω to V_{CC} – 2 V.

Product data

PCK210



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	1550E DATE
SOT358 -1	136E03	MS-026			-00-01-19- 03-02-25



HVQFN32: plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 x 5 x 0.85 mm

PCK210

SOT617-1

PCK210

REVISION HISTORY

Rev	Date	Description
_3	20040423	Product data (9397 750 13083). Supersedes data of 2002 Dec 13 (9397 750 10866).
		Modifications:
		 Add Part type PCK210BS, HVQFN32 package option (SOT617-1).
		• Change temperature range in Ordering information table on page 2 from "-40 to +70 °C" to "-40 °C to +85 °C".
_2	20021213	Product data (9397 750 10866); ECN 853-2336 29225 of 22 November 2002.
		• NOTE: date shown on cover (2002 Nov 13) is incorrect. It should be "2002 Dec 13" as shown on all other pages and this Revision history table.
_1	20020411	Product data (9397 750 09657); ECN 853-2336 27995 of 11 April 2002.

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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